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Form PTD-1449 U.S. DEPARTMENT OF COMMERCE ATTY. DOCKET NO. 728-163 SERIAL NO. PATENT AND TRADEMARK OFFICE 09/502,729 INFORMATION DISCLOSURE STATEMENT BY APPLICANT (Use several sheets if necessary) **APPLICANT** Cohen, et al. FILING DATE February 11, 2000 GROUP Art Unit 2814 U.S. PATENT DOCUMENT **EXAMINER** FILING DATE INITIALS DOCUMENT NUMBER DATE NAME CLASS SUBCLASS 1 F APPROPRIATE いらし 8 6 5 01/19/99 Brasen, et al. WSL 05/28/96 Hori FOREIGN PATENT DOCUMENTS TRANSLATION DOCUMENT NUMBER DATE COUNTRY CLASS SUBCLASS YES NO 451 01/09/99 United Kingdom OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.) Conference Record of the 1988 IEEE International Symposium on Electrical Insulation, Cambridge USA, 5-8 June 1988, Gerstenberg, On structure and properties of plasma polymerized organo-silicon films , pages 141-144. EXAMINER DATE CONSIDERED EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant. (Form PTO-1449 [6-4])